

Crystal Oscillator Module ICs

OVERVIEW

The WF5025 series are miniature crystal oscillator module ICs. They feature a damping resistor R_D matched to the crystal's characteristics to reduce crystal current. The pad layout is arranged for flip chip mounting, which gives the pattern design more flexibility, even for mounting ultra-miniature crystal oscillators that provide almost no space for wiring patterns. They support fundamental oscillation and 3rd overtone oscillation modes. The WF5025 series can be used to correspond to wide range of applications.

FEATURES

- Pad layout optimized for flip chip mounting
- Miniature-crystal matched oscillator characteristics
- Operating supply voltage range
 - 2.5V operation: 2.25 to 2.75V
 - 3.0V operation: 2.7 to 3.6V
- Recommended operating frequency range
 - · For fundamental oscillator
 - WF5025AL×: 20MHz to 50MHz
 - WF5025BL1: 20MHz to 100MHz
 - For 3rd overtone oscillator
 - WF5025ML×: 70MHz to 133MHz
- -40 to 85°C operating temperature range
- Oscillator capacitor with excellent frequency characteristics built-in

- Oscillator circuit with damping resistor R_D builtin for reduced crystal current
- Standby function
 - High impedance in standby mode, oscillator stops
- Low standby current
 - Power-saving pull-up resistor built-in
- Oscillation detector function
- Frequency divider built-in (WF5025AL×)
 - varies with version: f_0 , $f_0/2$, $f_0/4$, $f_0/8$, $f_0/16$,
- CMOS output duty level (1/2VDD)
- $50 \pm 5\%$ output duty @ 1/2VDD
- 30pF output load
- Molybdenum-gate CMOS process

SERIES CONFIGURATION

| | Onevetina | | Recommended | Output | | | Standb | y mode |
|-------------|------------------------------|------------------|---|---|---------------------|----------------------|--------------------------------|--------------|
| Version | Operating supply voltage [V] | Oscillation mode | operating frequency range (fundamental oscillation)*1 [MHz] | current (V _{DD} = 2.5V) [mA] | Output frequency | Output duty level | Oscillator stop function | Output state |
| WF5025AL1 | | MALM. | | | f _O | | | |
| WF5025AL2 | | | | | f _O /2 | | | |
| WF5025AL3 | 2.25 to 3.6 | Fundamental | 20 to 50 | 4 | f _O /4 | CMOC | Yes | Hi-Z |
| WF5025AL4 | 2.20 10 3.0 | rundamentai | 20 10 50 | 4 | f _O /8 | CMOS | | П-2 |
| WF5025AL5 | 1 | | | | f _O /16 | | | NZSC. |
| WF5025AL6 | | | | | f _O /32 | 120 | WWW. | |
| WF5025BL1*2 | 2.25 to 3.6 | Fundamental | 20 to 100 | 8 | f _O | CMOS | Yes | Hi-Z |
| WF5025MLA | | | 70 to 80 | | | | | |
| (WF5025MLB) | 2.25 to 3.6 | 3rd overtone | 80 to 100 | 8 | f _O | CMOS | Yes | Hi-Z |
| WF5025MLC | | | 90 to 133 | | | | | |

^{*1.} The recommended operating frequency is a yardstick value derived from the crystal used for NPC characteristics authentication. However, the oscillator frequency band is not guaranteed. Specifically, the characteristics can vary greatly due to crystal characteristics and mounting conditions, so the oscillation characteristics of components must be carefully evaluated.

Note. These versions in parentheses () are under development. Please ask our Sales & Marketing section for further detail.

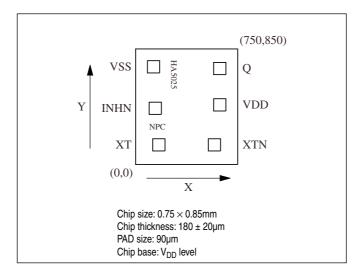
ORDERING INFORMATION

| Device | Package |
|-------------|------------|
| WF5025×××-3 | Wafer form |

^{*2.} The WF5025BL1 has a higher maximum operating frequency, hence the negative resistance is also larger than in the WF5025AL× devices.

PAD LAYOUT

(Unit: µm)

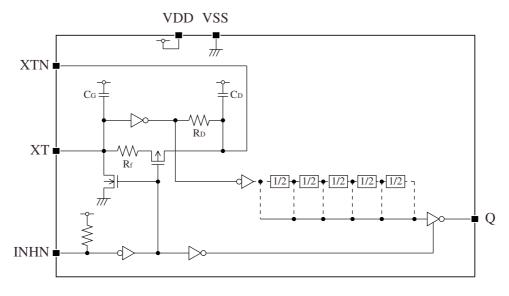


PIN DESCRIPTION and PAD DIMENSIONS

| Name | 1/0 | | Pad dimensions [µm] | | |
|------|-----|---|--|-------|-------|
| Name | I/O | | Description | Х | Υ |
| INHN | I | Output state control input. Power-saving pull-up resist | High impedance when LOW (oscillator stops). tor built-in. | 144.6 | 413.4 |
| XT | I | Amplifier input | Crystal connection pins. | 171.0 | 144.6 |
| XTN | 0 | Amplifier output | Crystal is connected between XT and XTN. | 579.0 | 144.6 |
| VDD | - | Supply voltage | | 618.2 | 438.6 |
| Q | 0 | | Output. Output frequency determined by internal circuit to one of f_O , $f_O/2$, $f_O/4$, $f_O/8$, $f_O/16$, $f_O/32$. High impedance in standby mode | | 705.4 |
| VSS | - | Ground | | 131.8 | 718.2 |

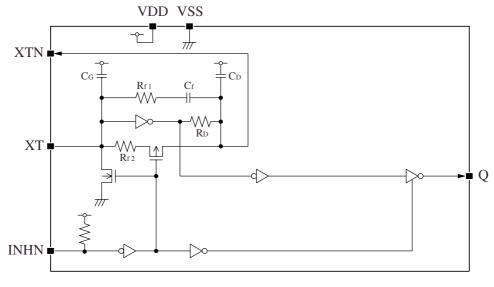
BLOCK DIAGRAM

For Fundamental Oscillator (WF5025AL×, WF5025BL1)



INHN = LOW active

For 3rd Overtone Oscillator (WF5025ML×)



INHN = LOW active

SPECIFICATIONS

Absolute Maximum Ratings

 $V_{SS} = 0V$

| Parameter | Symbol | Condition | Rating | Unit |
|-----------------------------|------------------|-----------|-------------------------------|------|
| Supply voltage range | V _{DD} | | -0.5 to +7.0 | V |
| Input voltage range | V _{IN} | | -0.5 to V _{DD} + 0.5 | V |
| Output voltage range | V _{OUT} | | -0.5 to V _{DD} + 0.5 | V |
| Operating temperature range | T _{opr} | | -40 to +85 | °C |
| Storage temperature range | T _{STG} | | -65 to +150 | °C |
| Output current | l _{OUT} | | 20 | mA |

Recommended Operating Conditions

$$V_{SS} = 0V$$

| Parameter | Symbol | Condition | | | | Unit | |
|--------------------------|------------------|-------------|-----------------------|-----------------|-----|-----------------|-------|
| rarameter | Syllibol | | Condition | | typ | max | Ollit |
| | | WF5025AL× | CL ≤ 30pF | 2.25 | - | 3.6 | ٧ |
| Operating supply voltage | | WF5025BL1 | CL ≤ 30pF | 2.25 | - | 3.6 | V |
| | V | WF5025MLA | f ≤ 80MHz, CL ≤ 30pF | 2.25 | - | 3.6 | ٧ |
| | V _{DD} | WF5025MLB | f ≤ 100MHz, CL ≤ 30pF | (2.25) | - | (3.6) | V |
| | | WF5025MLC | f ≤ 100MHz, CL ≤ 30pF | 2.25 | - | 3.6 | ٧ |
| | | | f ≤ 133MHz, CL ≤ 15pF | 2.25 | - | 3.6 | ٧ |
| Input voltage | V _{IN} | | | V _{SS} | - | V _{DD} | ٧ |
| Operating temperature | T _{OPR} | | | -40 | - | +85 | °C |
| | | WF5025AL× | WF5025AL× | | - | 50 | MHz |
| | | WF5025BL1*3 | | 20 | - | 100 | MHz |
| Operating frequency*2 | f _O | WF5025MLA | | 70 | - | 80 | MHz |
| | | WF5025MLB*3 | | (80) | - | (100) | MHz |
| | | WF5025MLC*3 | l | 90 | - | 133 | MHz |

^{*1.} Values in parentheses () are provisional only.

^{*2.} The operating frequency is a yardstick value derived from the crystal used for NPC characteristics authentication. However, the oscillator frequency band is not guaranteed. Specifically, the characteristics can vary greatly due to crystal characteristics and mounting conditions, so the oscillation characteristics of components must be carefully evaluated.

^{*3.} When 2.5V operation, the ratings of switching characteristics are difference by the frequency or output load. Refer to "Switching Characteristics".

Electrical Characteristics

WF5025AL× (2.5V operation)

 V_{DD} = 2.25 to 2.75V, V_{SS} = 0V, Ta = -40 to +85°C unless otherwise noted.

| Parameter | Cumbal | Condition | | Rating | | | |
|--|------------------|--|-----------------------------------|--------------------|------|--------------------|------|
| Parameter | Symbol | Condition | | min | typ | max | Unit |
| HIGH-level output voltage | V _{OH} | Q: Measurement cct 1, V _{DD} = 2.25V, I _C | _{OH} = 4mA | 1.65 | 1.95 | - | ٧ |
| LOW-level output voltage | V _{OL} | Q: Measurement cct 2, V _{DD} = 2.25V, I _C | _{DL} = 4mA | _ | 0.3 | 0.4 | ٧ |
| HIGH-level input voltage | V _{IH} | INHN | | 0.7V _{DD} | - | - | ٧ |
| LOW-level input voltage | V _{IL} | INHN | | _ | - | 0.3V _{DD} | ٧ |
| Output looks as assessed | | Q: Measurement cct 2, INHN = LOW | $V_{OH} = V_{DD}$ | _ | - | 10 | μΑ |
| Output leakage current | l _Z | Q: Measurement cct 2, INFIN = LOW | V _{OL} = V _{SS} | _ | - | 10 | μΑ |
| | | Measurement cct 3, load cct 1, INHN = open, C _L = 30pF, f = 50MHz | WF5025AL1 | _ | 7 | 14 | mA |
| | | | WF5025AL2 | _ | 4.5 | 9 | mA |
| Command and a support | I _{DD2} | | WF5025AL3 | _ | 3.5 | 7 | mA |
| Current consumption | | | WF5025AL4 | _ | 2.9 | 5.8 | mA |
| | | | WF5025AL5 | _ | 2.5 | 5 | mA |
| | | | WF5025AL6 | _ | 2.4 | 4.8 | mA |
| Standby current | I _{ST} | Measurement cct 3, INHN = LOW | | _ | - | 3 | μA |
| INITINI multum vasietamas | R _{UP1} | Measurement cct 4 | | 2 | 6 | 12 | MΩ |
| INHN pull-up resistance | R _{UP2} | Measurement cct 4 | | 20 | 100 | 200 | kΩ |
| Feedback resistance | R _f | Measurement cct 5 | | 50 | - | 150 | kΩ |
| Oscillator amplifier output resistance | R _D | Design value. A monitor pattern on a v | vafer is tested. | 340 | 400 | 460 | Ω |
| Puilt in conscitones | C _G | Decign value A monitor nottern an au | vofor in tootod | 6.8 | 8 | 9.2 | pF |
| Built-in capacitance | C _D | Design value. A monitor pattern on a v | valei is lesieu. | 8.5 | 10 | 11.5 | pF |

WF5025AL× (3.0V operation)

 V_{DD} = 2.7 to 3.6V, V_{SS} = 0V, Ta = -40 to +85°C unless otherwise noted.

| Parameter | Symbol | Condition | | | Rating | | Unit |
|--|------------------|--|-----------------------------------|--------------------|--------|--------------------|------|
| Parameter | Symbol | Condition | | min | typ | max | Unit |
| HIGH-level output voltage | V _{OH} | Q: Measurement cct 1, V _{DD} = 2.7V, I _{OI} | H = 4mA | 2.3 | 2.4 | - | ٧ |
| LOW-level output voltage | V _{OL} | Q: Measurement cct 2, V _{DD} = 2.7V, I _{OI} | = 4mA | - | 0.3 | 0.4 | V |
| HIGH-level input voltage | V _{IH} | INHN | | 0.7V _{DD} | - | _ | V |
| LOW-level input voltage | V _{IL} | INHN | | - | - | 0.3V _{DD} | ٧ |
| Output looks as assessed | | O. Massurament act O. INLIN. J. O.W. | $V_{OH} = V_{DD}$ | - | - | 10 | μA |
| Output leakage current | l _Z | Q: Measurement cct 2, INHN = LOW | V _{OL} = V _{SS} | - | - | 10 | μΑ |
| | | Measurement cct 3, load cct 1, INHN = open, C _L = 30pF, f = 50MHz | WF5025AL1 | - | 8.5 | 17 | mA |
| | | | WF5025AL2 | - | 5.5 | 11 | mA |
| Command and a support | I _{DD2} | | WF5025AL3 | - | 4 | 8 | mA |
| Current consumption | | | WF5025AL4 | - | 3.3 | 6.6 | mA |
| | | | WF5025AL5 | _ | 2.9 | 5.8 | mA |
| | | | WF5025AL6 | - | 2.7 | 5.4 | mA |
| Standby current | I _{ST} | Measurement cct 3, INHN = LOW | | - | - | 5 | μΑ |
| INILINI mullum vasistamas | R _{UP1} | Measurement cct 4 | | 2 | 4 | 8 | MΩ |
| INHN pull-up resistance | R _{UP2} | weasurement cct 4 | | 15 | 75 | 150 | kΩ |
| Feedback resistance | R _f | Measurement cct 5 | | 50 | - | 150 | kΩ |
| Oscillator amplifier output resistance | R _D | Design value. A monitor pattern on a v | vafer is tested. | 340 | 400 | 460 | Ω |
| Puilt in consoitance | C _G | Decign value A monitor nottern on a v | rafar in tootad | 6.8 | 8 | 9.2 | pF |
| Built-in capacitance | C _D | Design value. A monitor pattern on a v | raiei is lesteu. | 8.5 | 10 | 11.5 | pF |

WF5025BL1 (2.5V operation)

 $V_{\rm DD}$ = 2.25 to 2.75V, $V_{\rm SS}$ = 0V, Ta = -40 to +85°C unless otherwise noted.

| Parameter | Combal | Condition | | Rating | | Unit | |
|--|------------------|--|---|--------------------|------|--------------------|------|
| Parameter | Symbol | Condition | | min | typ | max | Unit |
| HIGH-level output voltage | V _{OH} | Q: Measurement cct 1, V _{DD} = 2.25V, I ₀ | OH = 8mA | 1.65 | 1.95 | - | ٧ |
| LOW-level output voltage | V _{OL} | Q: Measurement cct 2, V _{DD} = 2.25V, I _{OL} = 8mA | | - | 0.3 | 0.4 | ٧ |
| HIGH-level input voltage | V _{IH} | INHN | | 0.7V _{DD} | - | - | ٧ |
| LOW-level input voltage | V _{IL} | INHN | NHN | | | 0.3V _{DD} | ٧ |
| Output leakage current | | O. Maccurement act 2 INLIN I OW | $V_{OH} = V_{DD}$ | - | - | 10 | μΑ |
| | IZ | Q: Measurement cct 2, INHN = LOW | V _{OL} = V _{SS} | - | - | 10 | μA |
| Current consumption | I _{DD2} | Measurement cct 3, load cct 1, INHN = f = 100MHz | Measurement cct 3, load cct 1, INHN = open, C _L = 30pF, f = 100MHz | | 14 | 28 | mA |
| Standby current | I _{ST} | Measurement cct 3, INHN = LOW | | - | - | 3 | μA |
| INILINI and manistance | R _{UP1} | Management and 4 | | 2 | 6 | 12 | MΩ |
| INHN pull-up resistance | R _{UP2} | Measurement cct 4 | | 20 | 100 | 200 | kΩ |
| Feedback resistance | R _f | Measurement cct 5 | | 50 | - | 150 | kΩ |
| Oscillator amplifier output resistance | R _D | Design value. A monitor pattern on a wafer is tested. | | 170 | 200 | 230 | Ω |
| Duilt in conscitones | C _G | Design value A monitor notters as a | uafar ia taatad | 6.8 | 8 | 9.2 | pF |
| Built-in capacitance | C _D | Design value. A monitor pattern on a v | valer is tested. | 8.5 | 10 | 11.5 | pF |

WF5025BL1 (3.0V operation)

 $V_{\rm DD}$ = 2.7 to 3.6V, $V_{\rm SS}$ = 0V, Ta = -40 to +85°C unless otherwise noted.

| Downwater | Complete | Ocudition | | | | Unit | |
|--|------------------|---|---|--------------------|-----|--------------------|------|
| Parameter | Symbol | Condition | | min | typ | max | Unit |
| HIGH-level output voltage | V _{OH} | Q: Measurement cct 1, V _{DD} = 2.7V, I _O | H = 8mA | 2.3 | 2.4 | _ | V |
| LOW-level output voltage | V _{OL} | Q: Measurement cct 2, V _{DD} = 2.7V, I _O | _L = 8mA | - | 0.3 | 0.4 | V |
| HIGH-level input voltage | V _{IH} | NHN | | 0.7V _{DD} | - | - | V |
| LOW-level input voltage | V _{IL} | INHN | IHN | | | 0.3V _{DD} | ٧ |
| Output leakage current | | Q: Measurement cct 2, INHN = LOW | $V_{OH} = V_{DD}$ | - | - | 10 | μΑ |
| | l I _Z | | V _{OL} = V _{SS} | - | - | 10 | μΑ |
| Current consumption | I _{DD2} | Measurement cct 3, load cct 1, INHN = open, C _L = 30pF, f = 100MHz | | - | 19 | 38 | mA |
| Standby current | I _{ST} | Measurement cct 3, INHN = LOW | | _ | - | 5 | μΑ |
| INILINI mullum vasistamas | R _{UP1} | Measurement cct 4 | | 2 | 4 | 8 | ΜΩ |
| INHN pull-up resistance | R _{UP2} | weasurement cct 4 | | 15 | 75 | 150 | kΩ |
| Feedback resistance | R _f | Measurement cct 5 | | 50 | - | 150 | kΩ |
| Oscillator amplifier output resistance | R _D | Design value. A monitor pattern on a v | Design value. A monitor pattern on a wafer is tested. | | 200 | 230 | Ω |
| Duilt in conscitones | C _G | Design value A monitor nottorn on a c | uafar ia taatad | 6.8 | 8 | 9.2 | pF |
| Built-in capacitance | C _D | Design value. A monitor pattern on a v | valer is lested. | 8.5 | 10 | 11.5 | pF |

WF5025ML× (2.5V operation)

 V_{DD} = 2.25 to 2.75V, V_{SS} = 0V, Ta = -40 to +85°C unless otherwise noted.

| Dawamatan | Complete | Condition | | | Rating*1 | | | Unit |
|--|------------------|--|----------------------------|-----------------------------------|--------------------|------|--------------------|------|
| Parameter | Symbol | Condi | tion | | min | typ | max | Unit |
| HIGH-level output voltage | V _{OH} | Q: Measurement cct 1, V _{DD} = 2.2 | 25V, I _{OH} = 8mA | Ī | 1.65 | 1.95 | - | ٧ |
| LOW-level output voltage | V _{OL} | Q: Measurement cct 2, V _{DD} = 2.2 | 25V, I _{OL} = 8mA | ı | - | 0.3 | 0.4 | ٧ |
| HIGH-level input voltage | V _{IH} | INHN | | | 0.7V _{DD} | - | - | ٧ |
| LOW-level input voltage | V _{IL} | INHN | | | - | - | 0.3V _{DD} | ٧ |
| Output lookogo ourrent | | O: Macaurament act 2 INHN - I | OW | $V_{OH} = V_{DD}$ | - | - | 10 | μA |
| Output leakage current | I _Z | Q: Measurement cct 2, INHN = L | LOVV | V _{OL} = V _{SS} | - | - | 10 | μA |
| | | Measurement cct 3, load cct 1, INHN = open, C _L = 15pF | f = 100MHz | WF5025MLB | - | TBD | TBD | mA |
| | I _{DD1} | | f = 133MHz | WF5025MLC | - | 15 | 30 | mA |
| Current consumption | | | f = 72MHz | WF5025MLA | - | 11 | 22 | mA |
| | I _{DD2} | Measurement cct 3, load cct 1, INHN = open, C _L = 30pF | f = 100MHz | WF5025MLB | - | TBD | TBD | mA |
| | | anna spen, se sep. | f = 100MHz | WF5025MLC | - | 15 | 30 | mA |
| Standby current | I _{ST} | leasurement cct 3, INHN = LOW | | | - | - | 3 | μA |
| | R _{UP1} | Married and d | | | 2 | 6 | 12 | MΩ |
| INHN pull-up resistance | R _{UP2} | Measurement cct 4 | | | 20 | 100 | 200 | kΩ |
| | | Design value. A monitor pattern on a wafer is tested. WF5025MLA WF5025MLB | | | 3.99 | 4.7 | 5.41 | kΩ |
| AC feedback resistance | R _{f1} | | | | TBD | TBD | TBD | kΩ |
| | | tootou. | | WF5025MLC | 2.97 | 3.5 | 4.03 | kΩ |
| DC feedback resistance | R _{f2} | Measurement cct 5 | | | 50 | - | 150 | kΩ |
| Oscillator amplifier output resistance | R _D | Design value. A monitor pattern | on a wafer is te | ested. | 85 | 100 | 115 | Ω |
| AC feedback capacitance | C _f | Design value. A monitor pattern | on a wafer is te | ested. | 8.5 | 10 | 11.5 | pF |
| | | | | WF5025MLA | 1.70 | 2 | 2.30 | pF |
| | C _G | Design value. A monitor pattern tested. | on a wafer is | WF5025MLB | (1.70) | (2) | (2.30) | pF |
| Duilt in conseitence | | | | WF5025MLC | 0.85 | 1 | 1.15 | pF |
| Built-in capacitance | | | | WF5025MLA | 3.40 | 4 | 4.60 | pF |
| | C _D | Design value. A monitor pattern on a wafer is tested. | | WF5025MLB | (3.40) | (4) | (4.60) | pF |
| | | | WF5025ML | | 3.40 | 4 | 4.60 | pF |

^{*1.} Values in parentheses () are provisional only.

WF5025ML× (3.0V operation)

 V_{DD} = 2.7 to 3.6V, V_{SS} = 0V, Ta = -40 to +85°C unless otherwise noted.

| Dawa wa atau | Complete | Condition | | | | Rating*1 | | |
|--|------------------|---|--|-----------------------------------|--------------------|----------|--------------------|------|
| Parameter | Symbol | Condi | tion | | min | typ | max | Unit |
| HIGH-level output voltage | V _{OH} | Q: Measurement cct 1, V _{DD} = 2. | 7V, I _{OH} = 8mA | | 2.3 | 2.4 | - | ٧ |
| LOW-level output voltage | V _{OL} | Q: Measurement cct 2, V _{DD} = 2. | 7V, I _{OL} = 8mA | | - | 0.3 | 0.4 | ٧ |
| HIGH-level input voltage | V _{IH} | INHN | | | 0.7V _{DD} | - | - | ٧ |
| LOW-level input voltage | V _{IL} | INHN | | | - | - | 0.3V _{DD} | ٧ |
| Output leakage current | | Q: Measurement cct 2, INHN = L | OW | $V_{OH} = V_{DD}$ | - | - | 10 | μA |
| Output leakage current | I _Z | Q. Measurement cct 2, INFIN = L | LOVV | V _{OL} = V _{SS} | - | - | 10 | μA |
| | | Measurement cct 3, load cct 1, INHN = open, C _L = 15pF | f = 100MHz | WF5025MLB | - | TBD | TBD | mA |
| | I _{DD1} | | f = 133MHz | WF5025MLC | - | 20 | 40 | mA |
| Current consumption | | | f = 72MHz | WF5025MLA | - | 15 | 30 | mA |
| | I _{DD2} | Measurement cct 3, load cct 1, INHN = open, C _L = 30pF | f = 100MHz | WF5025MLB | - | TBD | TBD | mA |
| | | .,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,, | f = 100MHz | WF5025MLC | - | 20 | 40 | mA |
| Standby current | I _{ST} | leasurement cct 3, INHN = LOW | | | - | - | 5 | μA |
| INI INI mulli un vaciatance | R _{UP1} | - Measurement cct 4 | | | 2 | 4 | 8 | MΩ |
| INHN pull-up resistance | R _{UP2} | | | | 15 | 75 | 150 | kΩ |
| | R _{f1} | Design value. A monitor pattern on a wafer is tested. WF5025MLA WF5025MLB | | 3.99 | 4.7 | 5.41 | kΩ | |
| AC feedback resistance | | | | TBD | TBD | TBD | kΩ | |
| | | | WF5025MLC | | | 3.5 | 4.03 | kΩ |
| DC feedback resistance | R _{f2} | Measurement cct 5 | | • | 50 | - | 150 | kΩ |
| Oscillator amplifier output resistance | R _D | Design value. A monitor pattern | on a wafer is te | ested. | 85 | 100 | 115 | Ω |
| AC feedback capacitance | C _f | Design value. A monitor pattern | on a wafer is te | sted. | 8.5 | 10 | 11.5 | pF |
| | | | | WF5025MLA | 1.70 | 2 | 2.30 | pF |
| | C _G | Design value. A monitor pattern tested. | on a wafer is | WF5025MLB | (1.70) | (2) | (2.30) | pF |
| Built in conscitores | | | | WF5025MLC | 0.85 | 1 | 1.15 | pF |
| Built-in capacitance | | | | WF5025MLA | 3.40 | 4 | 4.60 | pF |
| | C _D | Design value. A monitor pattern tested. | Design value. A monitor pattern on a wafer is Wf | | (3.40) | (4) | (4.60) | pF |
| | | เธอเธน. | | WF5025MLC | 3.40 | 4 | 4.60 | pF |

^{*1.} Values in parentheses () are provisional only.

Switching Characteristics

WF5025AL× (2.5V operation)

 $V_{DD} = 2.25$ to 2.75V, $V_{SS} = 0$ V, Ta = -40 to +85°C unless otherwise noted.

| Parameter | Symbol Condition | | | | Unit | | |
|-----------------------------|------------------|--|-----------------------|-----|------|-------|----|
| raiailletei | Symbol | Condition | min | typ | max | Oilit | |
| Output rice time | t _{r1} | Measurement cct 3, load cct 1, | C _L = 15pF | - | 3 | 6 | ns |
| Output rise time | t _{r2} | 0.1V _{DD} to 0.9V _{DD} | C _L = 30pF | - | 5 | 10 | ns |
| Output fall time | t _{f1} | Measurement cct 3, load cct 1, | C _L = 15pF | - | 3 | 6 | ns |
| Output fall time | t _{f2} | 0.9V _{DD} to 0.1V _{DD} | C _L = 30pF | - | 5 | 10 | ns |
| Output duty cycle*1 | Duty1 | Measurement cct 3, load cct 1, | C _L = 15pF | 45 | - | 55 | % |
| Output duty cycle | LITY CYCIE ' | $V_{DD} = 2.5V$, Ta = 25°C, f = 50MHz | C _L = 30pF | 45 | - | 55 | % |
| Output disable delay time*2 | t _{PLZ} | Measurement cct 6, load cct 1, V _{DD} = | 2.5V, Ta = 25°C, | - | - | 100 | ns |
| Output enable delay time*2 | t _{PZL} | C _L = 15pF | | - | - | 100 | ns |

 $^{^{\}star}1.$ The duty cycle characteristic is checked the sample chips of each production lot.

WF5025AL× (3.0V operation)

 V_{DD} = 2.7 to 3.6V, V_{SS} = 0V, Ta = -40 to +85°C unless otherwise noted.

| Parameter | Cumhal | Condition | Rating | | | Unit | |
|-----------------------------|------------------|--|-------------------------------|-------------|-----|--------|----|
| Parameter | Symbol | Condition | | min typ max | | J Gill | |
| Output rise time | t _{r1} | Measurement cct 3, load cct 1, | C _L = 15pF | - | 2.5 | 5 | ns |
| Output rise time | t _{r2} | 0.1V _{DD} to 0.9V _{DD} | $C_L = 30pF$ – $C_L = 15pF$ – | _ | 4.5 | 9 | ns |
| Output fall time | t _{f1} | 0.01/ to 0.11/ | C _L = 15pF | _ | 2.5 | 5 | ns |
| Output fail time | t _{f2} | | _ | 4.5 | 9 | ns | |
| Output duty cycle*1 | Duty1 | Measurement cct 3, load cct 1, | C _L = 15pF | 45 | - | 55 | % |
| Output duty cycle | Duty2 | $V_{DD} = 3.0V$, Ta = 25°C, f = 50MHz | C _L = 30pF | 45 | - | 55 | % |
| Output disable delay time*2 | t _{PLZ} | Measurement cct 6, load cct 1, V _{DD} = | 3.0V, Ta = 25°C, | - | - | 100 | ns |
| Output enable delay time*2 | t _{PZL} | C _L = 15pF | | - | - | 100 | ns |

^{*1.} The duty cycle characteristic is checked the sample chips of each production lot.

^{*2.} Oscillator stop function is built-in. When INHN goes LOW, normal output stops. When INHN goes HIGH, normal output is not resumed until after the oscillator start-up time has elapsed.

^{*2.} Oscillator stop function is built-in. When INHN goes LOW, normal output stops. When INHN goes HIGH, normal output is not resumed until after the oscillator start-up time has elapsed.

WF5025BL1 (2.5V operation)

 $V_{\rm DD}$ = 2.25 to 2.75V, $V_{\rm SS}$ = 0V, Ta = -40 to +85°C unless otherwise noted.

| Dovomotov | Cumhal | Condition | | Unit | | | | |
|-----------------------------|------------------|---|-------------------------------------|------|-----|-----|-------|--|
| Parameter | Symbol | Condition | | min | typ | max | Oilit | |
| | t _{r1} | Measurement cct 3, load cct 1, | C _L = 15pF | - | 2 | 4 | ns | |
| Output rise time | t _{r2} | 0.1V _{DD} to 0.9V _{DD} | C _L = 30pF | _ | 3 | 6 | ns | |
| · | t _{r3} | Measurement cct 3, load cct 1, 0.2V _{DD} to 0.8V _{DD} | C _L = 30pF | _ | 2.5 | 5 | ns | |
| | t _{f1} | Measurement cct 3, load cct 1, | C _L = 15pF | - | 2 | 4 | ns | |
| Output fall time | t _{f2} | 0.9V _{DD} to 0.1V _{DD} | C _L = 30pF | - | 3 | 6 | ns | |
| | t _{f3} | Measurement cct 3, load cct 1, 0.8V _{DD} to 0.2V _{DD} | C _L = 30pF | - | 2.5 | 5 | ns | |
| | Duty1 | | C _L = 15pF f = 100MHz | 45 | - | 55 | % | |
| Output duty cycle*1 | Duty2 | Measurement cct 3, load cct 1, V _{DD} = 2.5V, Ta = 25°C | C _L = 30pF f = 80MHz | 45 | - | 55 | % | |
| | Duty3 | | C _L = 30pF f = 100MHz | 40 | - | 60 | % | |
| Output disable delay time*2 | t _{PLZ} | Measurement cct 6, load cct 1, V_{DD} = 2.5V, Ta = 25°C, C_L = 15pF | | - | - | 100 | ns | |
| Output enable delay time*2 | t _{PZL} | | | - | - | 100 | ns | |

^{*1.} The duty cycle characteristic is checked the sample chips of each production lot.

WF5025BL1 (3.0V operation)

 $V_{\rm DD}$ = 2.7 to 3.6V, $V_{\rm SS}$ = 0V, Ta = -40 to +85°C unless otherwise noted.

| Parameter | Symbol | Condition | Rating | | | Unit | |
|-----------------------------|------------------|---|-----------------------|-------------|-----|------|----|
| raiailletei | Symbol | Condition | | min typ max | | | |
| Output rise time | t _{r1} | Measurement cct 3, load cct 1, | C _L = 15pF | - | 1.5 | 3 | ns |
| Output rise time | t _{r2} | 0.1V _{DD} to 0.9V _{DD} | C _L = 30pF | _ | 2.5 | 5 | ns |
| Output fall time | t _{f1} | Measurement cct 3, load cct 1, 0.9V _{DD} to 0.1V _{DD} | C _L = 15pF | _ | 1.5 | 3 | ns |
| Output fair time | t _{f2} | | C _L = 30pF | _ | 2.5 | 5 | ns |
| Output duty cycle*1 | Duty1 | Measurement cct 3, load cct 1, | C _L = 15pF | 45 | _ | 55 | % |
| Output duty cycle | Duty2 | $V_{DD} = 3.0V$, Ta = 25°C, f = 100MHz | C _L = 30pF | 45 | _ | 55 | % |
| Output disable delay time*2 | t _{PLZ} | Measurement cct 6, load cct 1, V _{DD} = | 3.0V, Ta = 25°C, | _ | _ | 100 | ns |
| Output enable delay time*2 | t _{PZL} | $C_L = 15pF$ | | - | - | 100 | ns |

^{*1.} The duty cycle characteristic is checked the sample chips of each production lot.

^{*2.} Oscillator stop function is built-in. When INHN goes LOW, normal output stops. When INHN goes HIGH, normal output is not resumed until after the oscillator start-up time has elapsed.

^{*2.} Oscillator stop function is built-in. When INHN goes LOW, normal output stops. When INHN goes HIGH, normal output is not resumed until after the oscillator start-up time has elapsed.

WF5025ML× (2.5V operation)

 $V_{DD} = 2.25$ to 2.75V, $V_{SS} = 0$ V, Ta = -40 to +85°C unless otherwise noted.

| Parameter | Cumbal | Condition | | | Rating*1 | | | Unit |
|-----------------------------|---------------------------|---|--------------------------------|-----------------------|----------|-------|------|------|
| Parameter | Symbol | | onaition | | min | O III | | |
| Output rise time | t _{r1} | Measurement cct 3, load of | Measurement cct 3, load cct 1, | | - | 2 | 4 | ns |
| Output rise time | t _{r2} | 0.1V _{DD} to 0.9V _{DD} | | C _L = 30pF | ı | 3 | 6 | ns |
| Output fall time | t _{f1} | Measurement cct 3, load cct 1, 0.9V _{DD} to 0.1V _{DD} | | C _L = 15pF | ı | 2 | 4 | ns |
| Output fail time | t _{f2} | | | C _L = 30pF | - | 3 | 6 | ns |
| | Duty1 | Measurement cct 3, load cct 1, V_{DD} = 2.5V, Ta = 25°C, C_L = 15pF | f = 72MHz | WF5025MLA | 45 | - | 55 | % |
| | | | f = 100MHz | WF5025MLB | (45) | - | (55) | % |
| Output duty cycle*2 | | | f = 133MHz | WF5025MLC | 45 | - | 55 | % |
| Output duty cycle | | , , | f = 72MHz | WF5025MLA | 45 | - | 55 | % |
| | Duty2 | | f = 100MHz | WF5025MLB | (40) | - | (60) | % |
| | $Ia = 25^{\circ}C, C_L =$ | Ta = 25°C, $C_L = 30pF$ | f = 100MHz | WF5025MLC | 40 | - | 60 | % |
| Output disable delay time*3 | t _{PLZ} | Measurement cct 6, load cct 1, V _{DD} = 2.5V, Ta = 25°C, | | _ | - | 100 | ns | |
| Output enable delay time*3 | t _{PZL} | C _L = 15pF | | | | - | 100 | ns |

^{*1.} Values in parentheses () are provisional only.

WF5025ML× (3.0V operation)

 $V_{\rm DD}$ = 2.7 to 3.6V, $V_{\rm SS}$ = 0V, Ta = -40 to +85°C unless otherwise noted.

| Parameter | Symbol | Condition | | | Rating*1 | | | Unit | |
|-----------------------------|------------------|---|---|-----------------------|-------------|-----|------|------|---|
| raiametei | Syllibol | | ilaition | | min typ max | | max | | |
| Output rise time | t _{r1} | Measurement cct 3, load cc | Measurement cct 3, load cct 1, | | - | 1.5 | 3 | ns | |
| Output rise time | t _{r2} | 0.1V _{DD} to 0.9V _{DD} | | C _L = 30pF | - | 2.5 | 5 | ns | |
| Output fall time | t _{f1} | Measurement cct 3, load cc | | | - | 1.5 | 3 | ns | |
| Output fail time | t _{f2} | 0.9V _{DD} to 0.1V _{DD} | | | - | 2.5 | 5 | ns | |
| | Measure | Measurement cct 3, load cct 1, V _{DD} = 3.0V, Ta = 25°C. C _L = 15pF | f = 72MHz | WF5025MLA | 45 | - | 55 | % | |
| | Duty1 | | f = 100MHz | WF5025MLB | (45) | - | (55) | % | |
| | | | $1a = 25^{\circ}C, C_{L} = 15pF$ $f = 130$ | f = 133MHz | WF5025MLC | 45 | - | 55 | % |
| Output duty cycle*2 | I | Measurement cct 3, | f = 72MHz | WF5025MLA | 45 | - | 55 | % | |
| Duty2 | Duty2 | load cct 1, V _{DD} = 3.0V, Ta = 25°C, C _L = 30pF | f = 100MHz | WF5025MLB | (45) | - | (55) | % | |
| | | | | 45 | - | 55 | % | | |
| Output disable delay time*3 | t _{PLZ} | Measurement cct 6, load cc | Measurement cct 6, load cct 1, V _{DD} = 3.0V, Ta = 25°C, | | - | - | 100 | ns | |
| Output enable delay time*3 | t _{PZL} | C _L = 15pF | | | | - | 100 | ns | |

^{*1.} Values in parentheses () are provisional only.

^{*2.} The duty cycle characteristic is checked the sample chips of each production lot.

^{*3.} Oscillator stop function is built-in. When INHN goes LOW, normal output stops. When INHN goes HIGH, normal output is not resumed until after the oscillator start-up time has elapsed.

^{*2.} The duty cycle characteristic is checked the sample chips of each production lot.

^{*3.} Oscillator stop function is built-in. When INHN goes LOW, normal output stops. When INHN goes HIGH, normal output is not resumed until after the oscillator start-up time has elapsed.

FUNCTIONAL DESCRIPTION

Standby Function

When INHN goes LOW, the oscillator stops and the oscillator output on Q becomes high impedance.

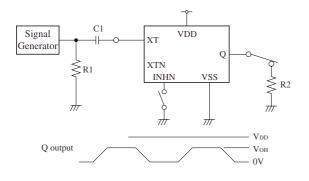
| Version | INHN | Q | Oscillator | |
|---------------------|----------------|---|------------------|--|
| WF5025AL× | HIGH (or open) | Any f _O , f _O /2, f _O /4, f _O /8, f _O /16 or f _O /32 output frequency | Normal operation | |
| WF5025BL1, ML× | nidh (oi open) | f _O | | |
| WF5025AL×, BL1, ML× | LOW | High impedance | Stopped | |

Power-save Pull-up Resistor

The INHN pull-up resistance changes in response to the input level (HIGH or LOW). When INHN goes LOW (standby state), the pull-up resistance becomes large to reduce the current consumption during standby.

MEASUREMENT CIRCUITS

Measurement cct 1



2Vp-p, 10MHz sine wave input signal C1: 0.001 μ F

R1: 50Ω

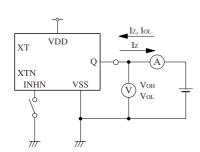
R2: 5025AL× : 412Ω (2.5V operation)

 575Ω (3.0V operation)

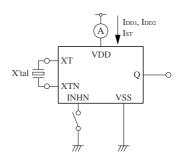
5025BL1, ML× : 206Ω (2.5V operation)

 287Ω (3.0V operation)

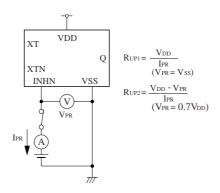
Measurement cct 2



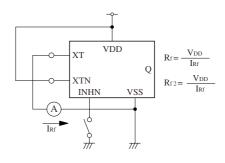
Measurement cct 3



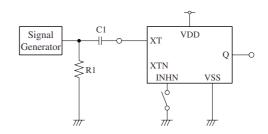
Measurement cct 4



Measurement cct 5



Measurement cct 6



2Vp-p, 10MHz sine wave input signal

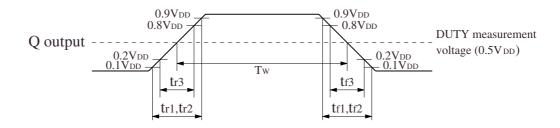
C1: 0.001μF R1: 50Ω

Load cct 1

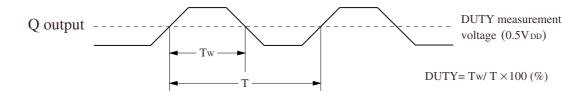


Switching Time Measurement Waveform

Output duty level, t_r, t_f

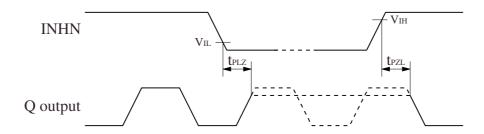


Output duty cycle



Output Enable/Disable Delay

when the device is in standby, the oscillator stops. When standby is released, the oscillator starts and stable oscillator output occurs after a short delay.



INHN input waveform $tr = tf \le 10$ ns

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